						Sheet 1 of 2				
HONDA TSUSHIN KOGYO CO., LTD. TOKYO JAPAN					D.	Date: Mar. 26, 2002				
				Approved b	y	Checked by	Checked by	Written by		
Product Specification Solder dip Male type for PC-Board				o <u>ard</u>	Minto	/	7-0000	J. hafine		
					Y.KATO		S.WATANABE	Y.ARAFUNE	S.MURAKAMI	
Pov. I			. 5,2015	S.MURAKAMI		Revision for RoHS				
			Date	Ву		Description				
1.Connector Part No. Type							Connecter Part No.			
Male Connector					Z-148,Z-149,Z-152,Z-152A (DIC-148,DIC-149,DIC-152,DIC-152A)					
	Fe	male Co	nnecto)r	Z-128,Z-129					
					(DIC-128,DIC-129) 2.Connector Characteristics					
No.	Item			Specification						
1	Current Rating	urrent Rating 1 amp DC			C maximum per contact					
2	Voltage Rating 125 vol			125 volts	25 volts AC (r.m.s.)					
3	Operating Temperature			-25 degree C \sim +80 degree C						
4	Operating Humidity			85 % maximum						
5	Structure, Form, Dimension			When tested in accordance with JIS C 5402 test 4.1, conform to referenced drawings.						
6	Material, Finish			When tested in accordance with JIS C 5402 test 4.2, conform to referenced drawings.						
7	Indication			When tested in accordance with JIS C 5402 test 4.4, conform to referenced drawings.						
8	Mating			When tested in accordance with JIS C 5402 test 4.3, unite with compatible connector.						
9	Insulation Resistance			When tested in accordance with method C of JIS C 5402 test 5.2, the insulation resistance shall be a minimum of 1000 M Ω at 500 volts DC.						
10	Dielectric Withstanding Voltage			When tested in accordance with method C of JIS C 5402 test 5.1, there shall be no breakdown of insulation or flashover at 1000 volts AC (r.m.s.) for a minute.						
11	Contact Resistance									
12	Female Contact Insertion and Withdrawal Force (Individual)									
13	Connector Insertion and Withdrawal Force (Overall)			H-11-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-1-						
14	Humidity			When tested in accordance with JIS C 5402 test 7.3, there shall be no evidence of cracking of the body or other physical damage to the connector. After test the insulation resistance shall be a minimum of $100~\text{M}\Omega$ at $500~\text{volts}$ DC and dielectric withstanding voltage shall be no breakdown of insulation or flashover at $1000~\text{volts}$ AC (r.m.s.) for a minute.						
				Test duration: 96 hours Temperature: 40 degree C						

No.	Item	Specification			
15	Temperature Cycling	When tested in accordance with JIS C 5402 test 7.2 (Temperature: -55 degree C \sim +85 degree C), there shall be no evidence of cracking of the body or other physical damage to the connector.			
16	Vibration	When tested in accordance with JIS C 5402 test 6.1 (10 Hz to 55 Hz, Amplitude: 1.52 mm, Acceleration: 98 m/s ²), there shall be no physical or mechanical damage to the connector.			
17	Shock	When tested in accordance with JIS C 5402 test 6.2 (Acceleration: 490 m/s ²), there shall be no physical or mechanical damage to the connector.			
18	Mechanical Operation (Durability)				
19	Corrosion (Salt spray)	When tested in accordance with JIS C 5402 test 7.1 (Temperature: +35 degree C, Concentration: 5 %, Duration: 48 hours), there shall be no evidence of cracking of the body or other physical damage to the connector.			
20	Resistance to H ₂ S Gas	When tested in accordance with JEIDA-38, there shall be no physical or mechanical damage to the connector. H2S gas concentration: 3 ppm Temperature: 40 degree C Test Time: 48 hours			
21	Resistance to Solder Heat	When tested in accordance with method 208E MIL-STD-202F (flow temperature 260 degree C, dipping time 5 sec), a through hole board with thickness of 1.6 mm contact termination area should be soldered correctly to the pad in PC board without any damage on the every part of connecter.			
22	Solder ability	When tested in accordance with JIS C 5402 test 7.11 (flow temperature 260 degree C, dipping time 5 sec), after the test, appearance the termination is 90 % covered by a cont new solder coating.			

Notes of soldering work

- 1. Flux should use the rosin system of noncorrosive.
- 2. Preheating should be controlled under 100 degree C.
- 3. Flow temperature under 260 degree C, dipping time under 5 sec.
- 4. After flow solder should surely perform flux washing. 1 Washing liquid: alcohol system
- 5. Please remove a conformity connector in the case of soldering.

Note

Refer to the product specification of a conformity connector about the item of No. #11, 12, 13, 18, 19 and 20.